

# Dual D-Type Flip-Flop with Set and Reset

## MC74VHC74, MC74VHCT74A

The MC74VHC74 and MC74VHCT74A are high speed CMOS D-Type Flip-Flops fabricated with silicon gate CMOS technology. These achieve high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

The signal level applied to the D input is transferred to Q output during the positive going transition of the Clock pulse.

Reset ( $\overline{RD}$ ) and Set ( $\overline{SD}$ ) are independent of the Clock (CP) and are accomplished by setting the appropriate input Low.

The MC74VHC74 inputs are compatible with standard CMOS levels while the MC74VHCT74A inputs are compatible with TTL levels. This device can be used as a level converter for interfacing 3.3 V to 5.0 V, because it has full 5.0 V CMOS level output swings.

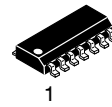
The MC74VHC74 and MC74VHCT74A internal circuits are composed of three stages, including a buffer output which provides high noise immunity and stable output. The input structures tolerate voltages up to 5.5 V, allowing the interface of 5 V systems to 3 V systems.

The MC74VHCT74A output structures provide protection when  $V_{CC} = 0$  V. These output structures help prevent device destruction caused by supply voltage – input/output voltage mismatch, battery backup, hot insertion, etc.

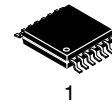
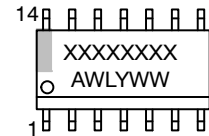
### Features

- High Speed:  $f_{max}$  (MC74VHC74) = 170 MHz (Typ) at  $V_{CC} = 5$  V  
 $f_{max}$  (MC74VHCT74A) = 60 MHz (Typ) at  $V_{CC} = 5$  V
- Low Power Dissipation:  $I_{CC} = 2 \mu A$  (Max) at  $T_A = 25^\circ C$
- High Noise Immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$
- Power Down Protection Provided on Inputs
- Balanced Propagation Delays
- Designed for 2.0 V to 5.5 V Operating Range
- Low Noise:  $V_{OLP} = 0.8$  V (Max)
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 100 mA
- ESD Performance:  
Human Body Model > 2000 V
- Chip Complexity: 128 FETs or 32 Equivalent Gates
- –Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

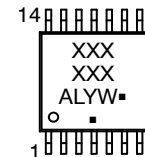
### MARKING DIAGRAMS



SOIC-14  
D SUFFIX  
CASE 751A



TSSOP-14  
DT SUFFIX  
CASE 948G



XXXXXX = Specific Device Code  
A = Assembly Location  
WL, L = Wafer Lot  
Y = Year  
WW, W = Work Week  
G or ■ = Pb-Free Package

(Note: Microdot may be in either location)

### FUNCTION TABLE

Inputs				Outputs	
SD	RD	CP	D	Q	$\overline{Q}$
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	H*	H*
H	H	$\nearrow$	H	H	L
H	H	$\searrow$	L	L	H
H	H	L	X	No Change	No Change
H	H	H	X	No Change	No Change
H	H	$\sim$	X	No Change	No Change

\*Both outputs will remain high as long as Set and Reset are low, but the output states are unpredictable if Set and Reset go high simultaneously.

### ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

# MC74VHC74, MC74VHCT74A

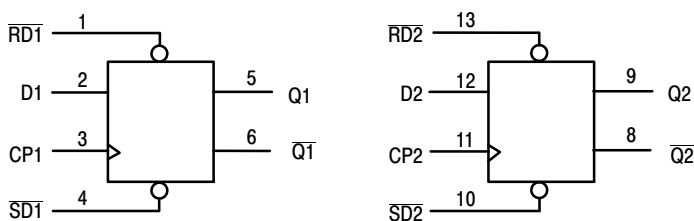


Figure 1. Logic Diagram

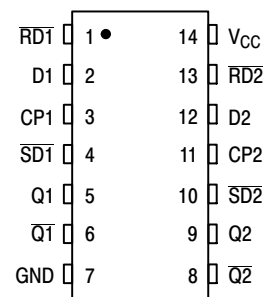


Figure 2. Pin Assignment

## MAXIMUM RATINGS

Symbol	Parameter	Value	Unit	
$V_{CC}$	DC Supply Voltage	-0.5 to +6.5	V	
$V_{in}$	DC Input Voltage	-0.5 to +6.5	V	
$V_{out}$	DC Output Voltage (MC74VHC)	-0.5 to $V_{CC} + 0.5$	V	
	DC Output Voltage (MC74VHCT)	Active Mode (High or Low State)		-0.5 to $V_{CC} + 0.5$
		Tristate Mode (Note 1) Power-Off Mode ( $V_{CC} = 0$ V)		-0.5 to +6.5 -0.5 to +6.5
$I_{IN}$	DC Input Current, per Pin	$\pm 20$	mA	
$I_{OUT}$	DC Output Current, Per Pin	$\pm 25$	mA	
$I_{CC}$	DC Supply Current, $V_{CC}$ and GND Pins	$\pm 50$	mA	
$I_{IK}$	Input Clamp Current	-20	mA	
$I_{OK}$	Output Clamp Current	MC74VHC	$\pm 20$	
		MC74VHCT	-20	
$T_{STG}$	Storage Temperature Range	-65 to +150	$^{\circ}C$	
$T_L$	Lead Temperature, 1 mm from Case for 10 secs	260	$^{\circ}C$	
$T_J$	Junction Temperature Under Bias	+150	$^{\circ}C$	
$\theta_{JA}$	Thermal Resistance (Note 2)	SOIC-14	116	
		QFN14	130	
		TSSOP-14	150	
$P_D$	Power Dissipation in Still Air at 25 $^{\circ}C$	SOIC-14	1077	
		QFN14	962	
		TSSOP-20	833	
MSL	Moisture Sensitivity	Level 1	-	
$F_R$	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	
$V_{ESD}$	ESD Withstand Voltage (Note 3)	Human Body Model	> 2000	
		Charged Device Model	2000	
$I_{LATCHUP}$	Latchup Performance (Note 4)	$\pm 100$	mA	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Applicable to devices with outputs that may be tri-stated.
2. Measured with minimum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.
3. HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.
4. Tested to EIA/JESD78 Class II.

# MC74VHC74, MC74VHCT74A

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
<b>MC74VHC</b>				
$V_{CC}$	DC Supply Voltage	2.0	5.5	V
$V_I$	DC Input Voltage (Note 5)	0	5.5	V
$V_O$	DC Output Voltage (Note 5)	0	$V_{CC}$	V
$T_A$	Operating Temperature	-55	+125	°C
$t_r, t_f$	Input Rise or Fall Rate	$V_{CC} = 3.0\text{ V to }3.6\text{ V}$ $V_{CC} = 4.5\text{ V to }5.5\text{ V}$	100 20	ns/V

## MC74VHCT

$V_{CC}$	DC Supply Voltage	2.0	5.5	V	
$V_{IN}$	DC Input Voltage (Note 5)	0	5.5	V	
$V_{OUT}$	DC Output Voltage (Note 5)	Active Mode (High or Low State) Tristate Mode Power-Off Mode ( $V_{CC} = 0\text{ V}$ )	0 0 0	$V_{CC}$ 5.5 5.5	V
$T_A$	Operating Temperature	-55	+125	°C	
$t_r, t_f$	Input Rise or Fall Rate	$V_{CC} = 4.5\text{ V to }5.5\text{ V}$	20	ns/V	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

5. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

## DC ELECTRICAL CHARACTERISTICS (MC74VHC74)

Symbol	Parameter	Test Conditions	$V_{CC}$ V	$T_A = 25^\circ\text{C}$			$T_A = -55^\circ\text{C to }+125^\circ\text{C}$		Unit
				Min	Typ	Max	Min	Max	
$V_{IH}$	Minimum High-Level Input Voltage		2.0 3.0 to 5.5	1.50 $V_{CC} \times 0.7$			1.50 $V_{CC} \times 0.7$		V
$V_{IL}$	Maximum Low-Level Input Voltage		2.0 3.0 to 5.5			0.50 $V_{CC} \times 0.3$		0.50 $V_{CC} \times 0.3$	V
$V_{OH}$	Minimum High-Level Output Voltage	$V_{in} = V_{IH}$ or $V_{IL}$ $I_{OH} = -50\ \mu\text{A}$	2.0 3.0 4.5	1.9 2.9 4.4	2.0 3.0 4.5		1.9 2.9 4.4		V
		$V_{in} = V_{IH}$ or $V_{IL}$ $I_{OH} = -4\ \text{mA}$ $I_{OH} = -8\ \text{mA}$	3.0 4.5	2.58 3.94		2.48 3.80			
$V_{OL}$	Maximum Low-Level Output Voltage	$V_{in} = V_{IH}$ or $V_{IL}$ $I_{OL} = 50\ \mu\text{A}$	2.0 3.0 4.5		0.0 0.0 0.0	0.1 0.1 0.1		0.1 0.1 0.1	V
		$V_{in} = V_{IH}$ or $V_{IL}$ $I_{OL} = 4\ \text{mA}$ $I_{OL} = 8\ \text{mA}$	3.0 4.5			0.36 0.36		0.44 0.44	
$I_{in}$	Maximum Input Leakage Current	$V_{in} = 5.5\text{ V or GND}$	0 to 5.5			$\pm 0.1$		$\pm 1.0$	$\mu\text{A}$
$I_{CC}$	Maximum Quiescent Supply Current	$V_{in} = V_{CC}$ or GND	5.5			2.0		20.0	$\mu\text{A}$

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# MC74VHC74, MC74VHCT74A

## AC ELECTRICAL CHARACTERISTICS (MC74VHC74)

Symbol	Parameter	Test Conditions	T <sub>A</sub> = 25°C			T <sub>A</sub> = -55°C to +125°C		Unit
			Min	Typ	Max	Min	Max	
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propagation Delay, CP to Q or $\bar{Q}$	V <sub>CC</sub> = 3.3 ± 0.3 V C <sub>L</sub> = 15 pF		6.7	11.9	1.0	14.0	ns
		C <sub>L</sub> = 50 pF		9.2	15.4	1.0	17.5	
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propagation Delay, SD or RD to Q or $\bar{Q}$	V <sub>CC</sub> = 3.3 ± 0.3 V C <sub>L</sub> = 15 pF		7.6	12.3	1.0	14.5	ns
		C <sub>L</sub> = 50 pF		10.1	15.8	1.0	18.0	
f <sub>max</sub>	Maximum Clock Frequency (50% Duty Cycle)	V <sub>CC</sub> = 3.3 ± 0.3 V C <sub>L</sub> = 15 pF	80	125		70		MHz
		C <sub>L</sub> = 50 pF	50	75		45		
f <sub>max</sub>	Maximum Clock Frequency (50% Duty Cycle)	V <sub>CC</sub> = 5.0 ± 0.5 V C <sub>L</sub> = 15 pF	130	170		110		MHz
		C <sub>L</sub> = 50 pF	90	115		75		
C <sub>in</sub>	Maximum Input Capacitance			4	10		10	pF

C <sub>PD</sub>	Power Dissipation Capacitance (Note 6)	Typical @ 25°C, V <sub>CC</sub> = 5.0 V		pF
		25		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

6. C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>/2 (per flip-flop). C<sub>PD</sub> is used to determine the no-load dynamic power consumption; P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.

## TIMING REQUIREMENTS (MC74VHC74)

Symbol	Parameter	V <sub>CC</sub> V	Guaranteed Limit		Unit
			T <sub>A</sub> = 25°C	T <sub>A</sub> = -55°C to +125°C	
t <sub>w</sub>	Minimum Pulse Width, CP	3.3 ± 0.3	6.0	7.0	ns
		5.0 ± 0.5	5.0	5.0	
t <sub>w</sub>	Minimum Pulse Width, $\bar{RD}$ or $\bar{SD}$	3.3 ± 0.3	6.0	7.0	ns
		5.0 ± 0.5	5.0	5.0	
t <sub>su</sub>	Minimum Setup Time, D to CP	3.3 ± 0.3	6.0	7.0	ns
		5.0 ± 0.5	5.0	5.0	
t <sub>h</sub>	Minimum Hold Time, D to CP	3.3 ± 0.3	0.5	0.5	ns
		5.0 ± 0.5	0.5	0.5	
t <sub>rec</sub>	Minimum Recovery Time, $\bar{SD}$ or $\bar{RD}$ to CP	3.3 ± 0.3	5.0	5.0	ns
		5.0 ± 0.5	3.0	3.0	

# MC74VHC74, MC74VHCT74A

## DC ELECTRICAL CHARACTERISTICS (MC74VHCT74A)

Symbol	Parameter	Test Conditions	V <sub>CC</sub> V	T <sub>A</sub> = 25°C			T <sub>A</sub> = - 55 to 125°C		Unit
				Min	Typ	Max	Min	Max	
V <sub>IH</sub>	Minimum High-Level Input Voltage		4.5 to 5.5	2.0			2.0		V
V <sub>IL</sub>	Maximum Low-Level Input Voltage		4.5 to 5.5			0.8		0.8	V
V <sub>OH</sub>	Minimum High-Level Output Voltage V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	4.5	4.4	4.5		4.4		V
		I <sub>OH</sub> = -8 mA	4.5	3.94			3.80		
V <sub>OL</sub>	Maximum Low-Level Output Voltage V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA	4.5		0.0	0.1		0.1	V
		I <sub>OL</sub> = 8 mA	4.5			0.36		0.44	
I <sub>in</sub>	Maximum Input Leakage Current	V <sub>in</sub> = 5.5 V or GND	0 to 5.5			±0.1		±1.0	μA
I <sub>CC</sub>	Maximum Quiescent Supply Current	V <sub>in</sub> = V <sub>CC</sub> or GND	5.5			2.0		20.0	μA
I <sub>CC(T)</sub>	Quiescent Supply Current	Per Input: V <sub>IN</sub> = 3.4 V Other Input: V <sub>CC</sub> or GND	5.5			1.35		1.50	mA
I <sub>OPD</sub>	Output Leakage Current	V <sub>OUT</sub> = 5.5 V	0			0.5		5.0	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## AC ELECTRICAL CHARACTERISTICS (MC74VHCT74A)

Symbol	Parameter	Test Conditions	T <sub>A</sub> = 25°C			T <sub>A</sub> = - 55 to 125°C		Unit
			Min	Typ	Max	Min	Max	
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propagation Delay, CP to Q or $\bar{Q}$	V <sub>CC</sub> = 5.0 ± 0.5 V C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF		5.8 6.3	7.8 8.8	1.0 1.0	9.0 10.0	ns
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propagation Delay, SD or RD to Q or $\bar{Q}$	V <sub>CC</sub> = 5.0 ± 0.5 V C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF		7.6 8.1	10.4 11.4	1.0 1.0	12.0 13.0	ns
f <sub>max</sub>	Maximum Clock Frequency (50% Duty Cycle)	V <sub>CC</sub> = 5.0 ± 0.5 V C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF	100 80	160 140		80 65		MHz
C <sub>in</sub>	Maximum Input Capacitance			4	10		10	pF

C <sub>PD</sub>	Power Dissipation Capacitance (Note 7)	Typical @ 25°C, V <sub>CC</sub> = 5.0 V		pF
		24		

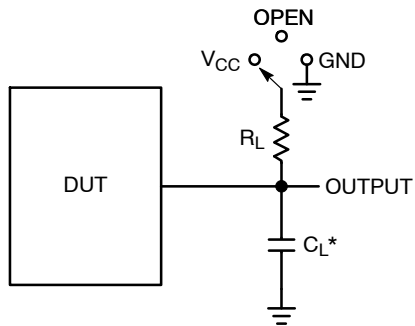
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

7. C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>/2 (per flip-flop). C<sub>PD</sub> is used to determine the no-load dynamic power consumption; P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.

## TIMING REQUIREMENTS (MC74VHCT74A)

Symbol	Parameter	V <sub>CC</sub> V	Guaranteed Limit		Unit
			T <sub>A</sub> = 25°C	T <sub>A</sub> = - 55 to 125°C	
t <sub>w</sub>	Minimum Pulse Width, CP	5.0 ± 0.5	5.0	5.0	ns
t <sub>w</sub>	Minimum Pulse Width, $\bar{R}\bar{D}$ or $\bar{S}\bar{D}$	5.0 ± 0.5	5.0	5.0	ns
t <sub>su</sub>	Minimum Setup Time, D to CP	5.0 ± 0.5	5.0	5.0	ns
t <sub>h</sub>	Minimum Hold Time, D to CP	5.0 ± 0.5	0.0	0.0	ns
t <sub>rec</sub>	Minimum Recovery Time, $\bar{S}\bar{D}$ or $\bar{R}\bar{D}$ to CP	5.0 ± 0.5	3.5	3.5	ns

# MC74VHC74, MC74VHCT74A



\*C<sub>L</sub> Includes probe and jig capacitance

Test	Switch Position	C <sub>L</sub>	R <sub>L</sub>
t <sub>PLH</sub> / t <sub>PHL</sub>	Open	See AC Characteristics Table	1 kΩ
t <sub>PLZ</sub> / t <sub>PZL</sub>	V <sub>CC</sub>		
t <sub>PHZ</sub> / t <sub>PZH</sub>	GND		

Figure 3. Test Circuit

## SWITCHING WAVEFORMS

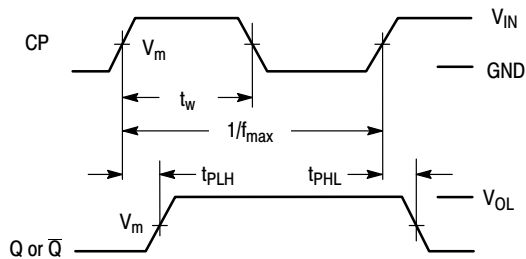


Figure 4.

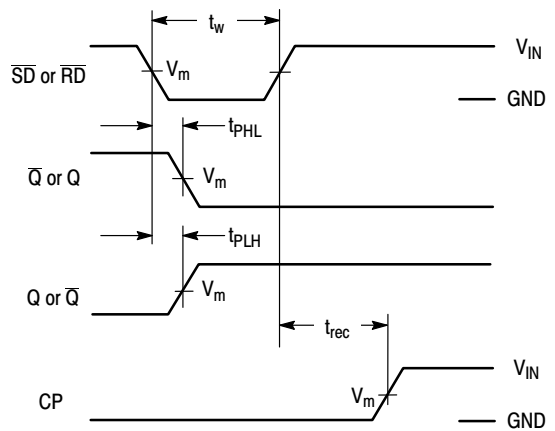


Figure 5.

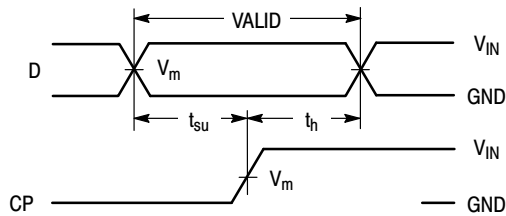


Figure 6.

Device	V <sub>IN</sub> , V	V <sub>m</sub> , V
MC74VHC74	V <sub>CC</sub>	50% x V <sub>CC</sub>
MC74VHCT74A	3 V	1.5 V

# MC74VHC74, MC74VHCT74A

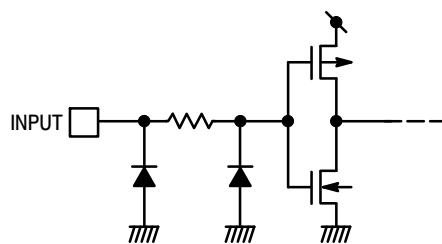


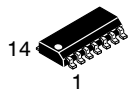
Figure 7. Input Equivalent Circuit

## ORDERING INFORMATION

Device	Package	Marking	Shipping†
MC74VHC74DR2G	SOIC-14	VHC74G	2500 / Tape & Reel
MC74VHC74DTG	TSSOP-14	VHC 74	96 Units / Rail
MC74VHC74DTR2G	TSSOP-14	VHC 74	2500 / Tape & Reel
MC74VHC74DTR2G-Q*	TSSOP-14	VHC 74	2500 / Tape & Reel
MC74VHCT74ADR2G	SOIC-14	VHCT74AG	2500 / Tape & Reel
MC74VHCT74ADTR2G	TSSOP-14	VHCT 74A	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

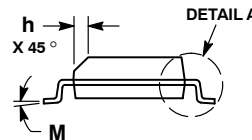
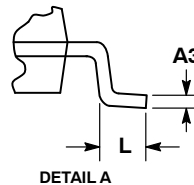
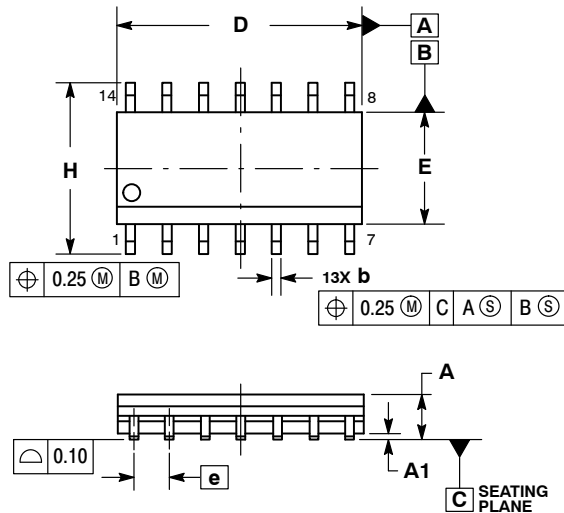
\*-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.



SCALE 1:1

SOIC-14 NB  
CASE 751A-03  
ISSUE L

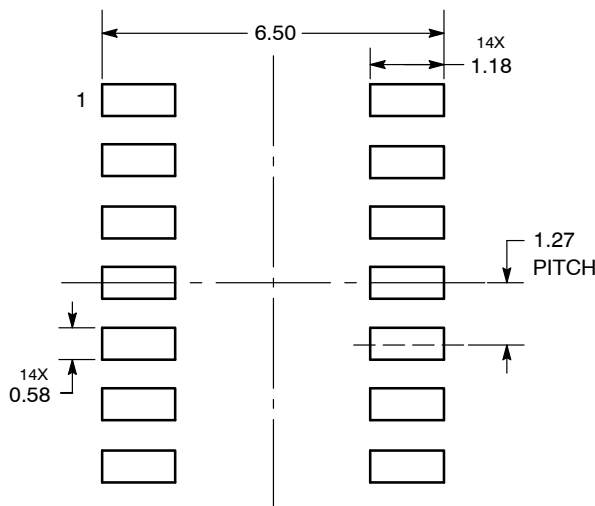
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- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
  3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF AT MAXIMUM MATERIAL CONDITION.
  4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.
  5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.054	0.068
A1	0.10	0.25	0.004	0.010
A3	0.19	0.25	0.008	0.010
b	0.35	0.49	0.014	0.019
D	8.55	8.75	0.337	0.344
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.019
L	0.40	1.25	0.016	0.049
M	0°	7°	0°	7°

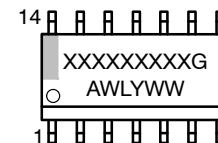
SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM\*



- XXXXXX = Specific Device Code
- A = Assembly Location
- WL = Wafer Lot
- Y = Year
- WW = Work Week
- G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

STYLES ON PAGE 2

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**SOIC-14**  
**CASE 751A-03**  
**ISSUE L**

DATE 03 FEB 2016

STYLE 1:  
 PIN 1. COMMON CATHODE  
 2. ANODE/CATHODE  
 3. ANODE/CATHODE  
 4. NO CONNECTION  
 5. ANODE/CATHODE  
 6. NO CONNECTION  
 7. ANODE/CATHODE  
 8. ANODE/CATHODE  
 9. ANODE/CATHODE  
 10. NO CONNECTION  
 11. ANODE/CATHODE  
 12. ANODE/CATHODE  
 13. NO CONNECTION  
 14. COMMON ANODE

STYLE 2:  
 CANCELLED

STYLE 3:  
 PIN 1. NO CONNECTION  
 2. ANODE  
 3. ANODE  
 4. NO CONNECTION  
 5. ANODE  
 6. NO CONNECTION  
 7. ANODE  
 8. ANODE  
 9. ANODE  
 10. NO CONNECTION  
 11. ANODE  
 12. ANODE  
 13. NO CONNECTION  
 14. COMMON CATHODE

STYLE 4:  
 PIN 1. NO CONNECTION  
 2. CATHODE  
 3. CATHODE  
 4. NO CONNECTION  
 5. CATHODE  
 6. NO CONNECTION  
 7. CATHODE  
 8. CATHODE  
 9. CATHODE  
 10. NO CONNECTION  
 11. CATHODE  
 12. CATHODE  
 13. NO CONNECTION  
 14. COMMON ANODE

STYLE 5:  
 PIN 1. COMMON CATHODE  
 2. ANODE/CATHODE  
 3. ANODE/CATHODE  
 4. ANODE/CATHODE  
 5. ANODE/CATHODE  
 6. NO CONNECTION  
 7. COMMON ANODE  
 8. COMMON CATHODE  
 9. ANODE/CATHODE  
 10. ANODE/CATHODE  
 11. ANODE/CATHODE  
 12. ANODE/CATHODE  
 13. NO CONNECTION  
 14. COMMON ANODE

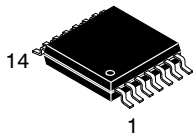
STYLE 6:  
 PIN 1. CATHODE  
 2. CATHODE  
 3. CATHODE  
 4. CATHODE  
 5. CATHODE  
 6. CATHODE  
 7. CATHODE  
 8. ANODE  
 9. ANODE  
 10. ANODE  
 11. ANODE  
 12. ANODE  
 13. ANODE  
 14. ANODE

STYLE 7:  
 PIN 1. ANODE/CATHODE  
 2. COMMON ANODE  
 3. COMMON CATHODE  
 4. ANODE/CATHODE  
 5. ANODE/CATHODE  
 6. ANODE/CATHODE  
 7. ANODE/CATHODE  
 8. ANODE/CATHODE  
 9. ANODE/CATHODE  
 10. ANODE/CATHODE  
 11. COMMON CATHODE  
 12. COMMON ANODE  
 13. ANODE/CATHODE  
 14. ANODE/CATHODE

STYLE 8:  
 PIN 1. COMMON CATHODE  
 2. ANODE/CATHODE  
 3. ANODE/CATHODE  
 4. NO CONNECTION  
 5. ANODE/CATHODE  
 6. ANODE/CATHODE  
 7. COMMON ANODE  
 8. COMMON ANODE  
 9. ANODE/CATHODE  
 10. ANODE/CATHODE  
 11. NO CONNECTION  
 12. ANODE/CATHODE  
 13. ANODE/CATHODE  
 14. COMMON CATHODE

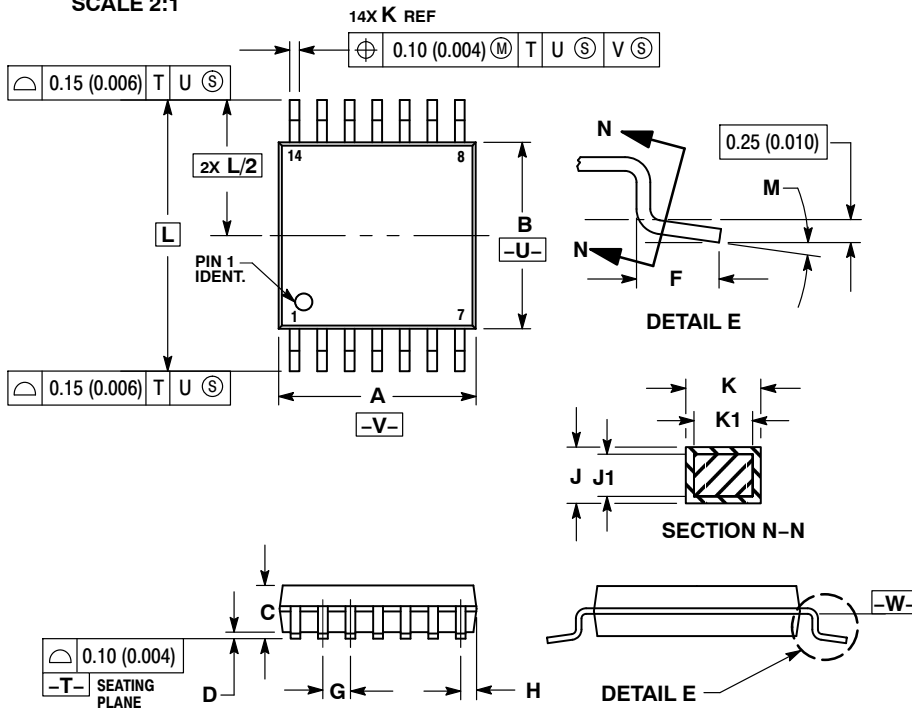
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TSSOP-14 WB  
CASE 948G  
ISSUE C

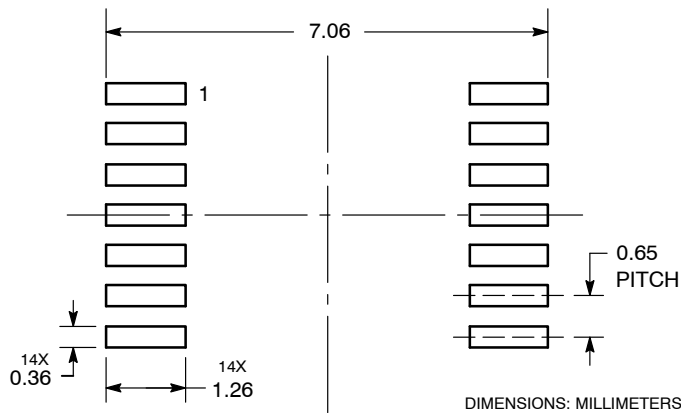
DATE 17 FEB 2016



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
  5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
  6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

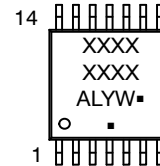
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	---	1.20	---	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

RECOMMENDED  
SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC  
MARKING DIAGRAM\*



- A = Assembly Location
- L = Wafer Lot
- Y = Year
- W = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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